

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
EFFECTIVE DATE:	07/27/2005
CONVEYING PARTY DATA	
Name	Execution Date
Jae Ho Yang	07/27/2005
Young Sik Ryu	07/27/2005
Sang Hyun Hong	07/27/2005
RECEIVING PARTY DATA	
Name:	Cheil Industries Inc.
Street Address:	290 Gongdan-dong, Gumi-shi
City:	Geongsangbuk-do
State/Country:	KOREA, REPUBLIC OF
Postal Code:	730-710
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	10529327
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OP \$40.00 10529327

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PATENT
REEL: 016336 FRAME: 0380

ASSIGNMENT

WHEREAS, WE, Sang Hyun Hong, Jae Ho Yang, and Young Sik Ryu (hereafter, ASSIGNORS), citizens of REPUBLIC OF KOREA respectively residing at 857-704 Seorak Apt., Suri-dong, Gumpo-si, Gyeonggi-do 435-753, Republic of Korea and 981-1205 Bakdu Apt., 1119 Sanbon-dong, Euiwang-si, Gyeonggi-do 435-040, Republic of Korea and 901-903 Sindonga Apt., Hoggie-dong, Dongan-gu, Anyang-si, Gyeonggi-do 431-080, Republic of Korea are the inventors of the invention in **FLAMEPROOF STYRENIC RESIN COMPOSITION** for which we have executed an application for Letters Patent of the United States, Serial No. 10 529 327 filed on March 25, 2005 .

and WHEREAS, CHEIL INDUSTRIES INC. (hereafter, ASSIGNEE), a corporation under the laws of Cheil Industries Inc., having a place of business at 290 Gongdan-dong, Gumi-si, Geongsangbuk-do 730-710, Republic of Korea is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEE the entire right, title and interest in, to and under all our inventions, whether joint or sole, disclosed in the said application and in, to and under all applications filed for Letters Patent of the United States for any of said inventions and in, to and under all patents granted on the said applications;

AND WE HEREBY further covenant and agree that we will communicate to the said ASSIGNEE, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, and execute all applications and papers necessary to obtain and maintain proper patent protection on said inventions;

AND WE HEREBY authorize and request the Commissioner of Patents and Trademarks of the United States to issue all patents on the said application to the said ASSIGNEE in accordance with the terms of this instrument;

IN TESTIMONY WHEREOF, We hereunto set our hands and seals on the date set opposite our respective signatures.

Date: July 27, 2005

S. H. Hong
Sang Hyun Hong

Date: July 27, 2005

Jae Ho Yang
Jae Ho Yang

Date: July 27, 2005

Young Sik Ryu
Young Sik Ryu

WITNESS:

Date: July 27, 2005

Hyejin Lee
Hyejin Lee